# LH534600

## CMOS 4M (512K × 8 / 256K × 16) Mask-Programmable ROM

### FEATURES

- 524,288 × 8 bit organization
  (Byte mode)
  262,144 × 16 bit organization
  (Word mode)
- $\overline{BYTE}$ input pin selects bit configuration
- Access time: 100 ns (MAX.)
- Low-power consumption:
  Operating: 550 mW (MAX.)
  Standby: 1.65 mW (MAX.)
- Static operation (Internal sync. system)
- Automatic power-down mode
- TTL compatible I/O
- Three-state outputs
- Single +5 V power supply
- Packages:
  40-pin, 600-mil DIP
  40-pin, 525-mil SOP
  44-pin, 14 × 14 mm$^2$ QFP
  48-pin, 12 × 18 mm$^2$ TSOP (Type I)
- X16 word-wide pinout

### DESCRIPTION

The LH534600 is a 4M bit mask-programmable ROM with two programmable memory organizations of byte and word modes. It is fabricated using silicon-gate CMOS process technology.

### PIN CONNECTIONS

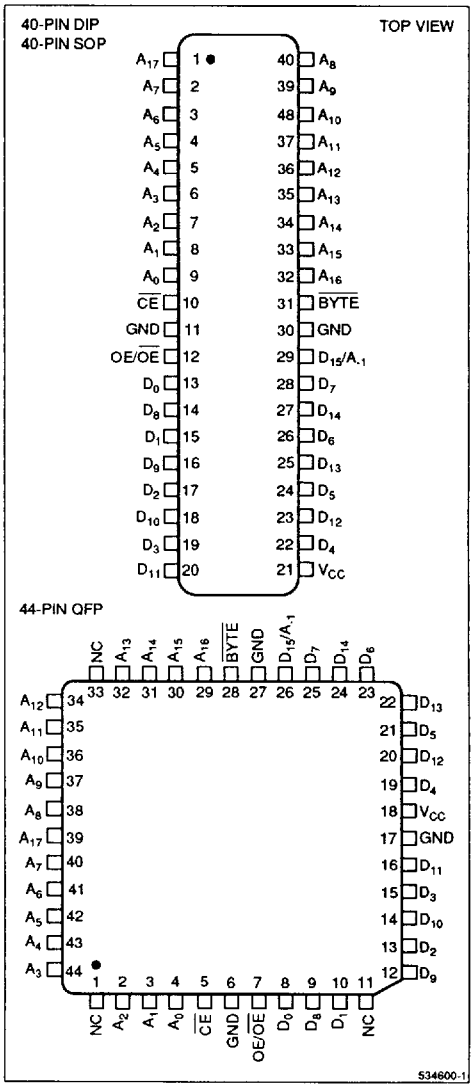



**Figure 1. Pin Connections for DIP, SOP, and QFP Packages**

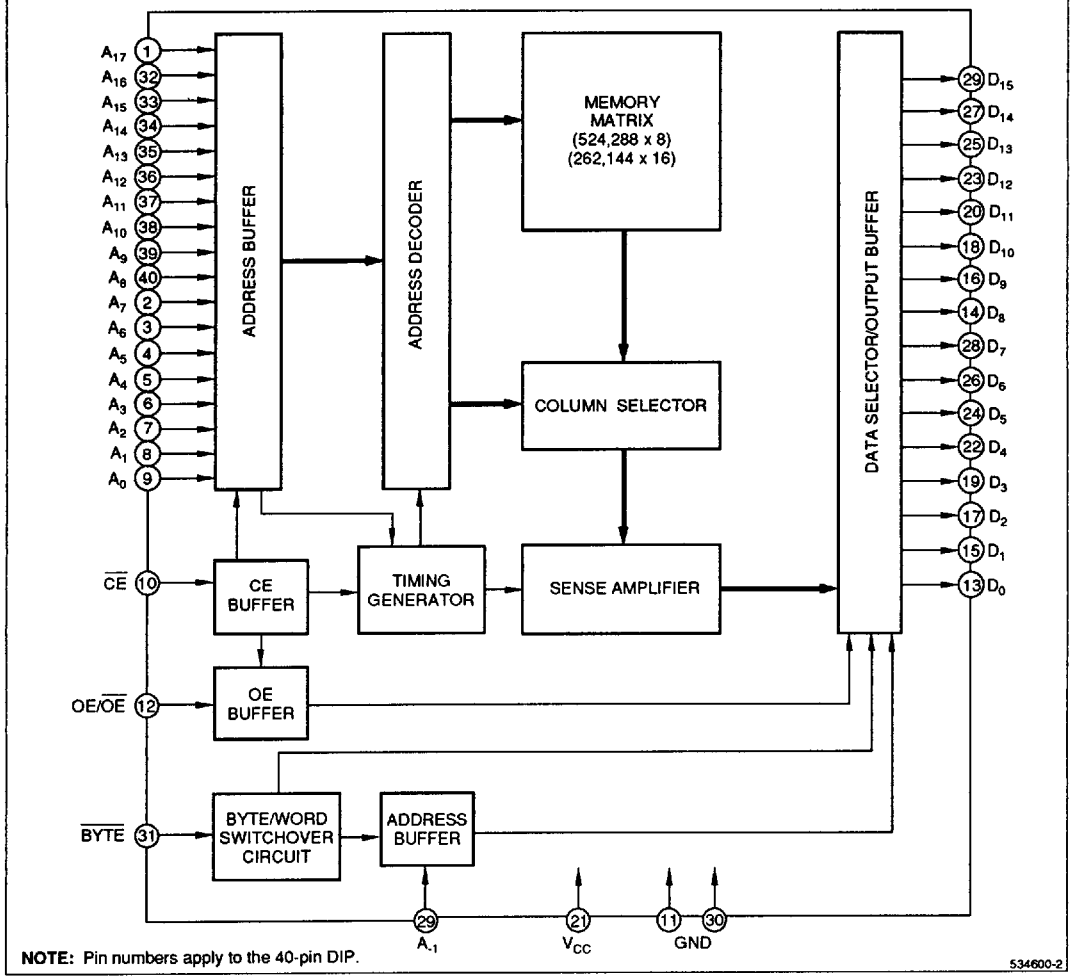



**Figure 2. LH534600 Block Diagram**

## PIN DESCRIPTION

| SIGNAL | PIN NAME | NOTE |
|---|---|---|
| $A_{-1}$ | Address input ($\overline{BYTE}$ MODE) | 1 |
| $A_0$ - $A_{17}$ | Address input | |
| $D_0$ - $D_{15}$ | Data output | |
| $\overline{CE}$ | Chip Enable input | |

| SIGNAL | PIN NAME | NOTE |
|---|---|---|
| OE/$\overline{OE}$ | Output Enable input | 2 |
| $\overline{BYTE}$ | Byte/word switch | |
| $V_{CC}$ | Power supply (+5 V) | |
| GND | Ground | |

**NOTES:**

1. $D_{15}/A_{-1}$ pin becomes LSB address input ($A_{-1}$) when the bit configuration is set in byte mode, and data output ($D_{15}$) when in word mode. $\overline{BYTE}$ input pin selects bit configuration.
2. Active level of OE/$\overline{OE}$ is mask-programmable.

## TRUTH TABLE

| $\overline{CE}$ | $\overline{OE}$ | $\overline{BYTE}$ | $A_{-1}$ | MODE | $D_0$ - $D_7$ | $D_8$ - $D_{15}$ | SUPPLY CURRENT | NOTE |
|---|---|---|---|---|---|---|---|---|
| H | X | X | X | Non selected | High-Z | | Standby ($I_{SB}$) | 1 |
| L | H | X | X | Non selected | High-Z | | Operating ($I_{CC}$) | |
| L | L | H | Input inhibit | Word | $D_0$ - $D_7$ | $D_8$ - $D_{15}$ | Operating ($I_{CC}$) | |
| L | L | L | L | Byte | $D_0$ - $D_7$ | High-Z | Operating ($I_{CC}$) | |
| L | L | L | H | Byte | $D_8$ - $D_{15}$ | High-Z | Operating ($I_{CC}$) | |

**NOTE:**
1. The input state of $\overline{BYTE}$ pin must not be changed during operation. The $\overline{BYTE}$ pin must be set to either High or Low. X = H or L

## ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | RATING | UNIT | NOTE |
|---|---|---|---|---|
| Supply voltage | $V_{CC}$ | -0.3 to +7.0 | V | 1 |
| Input voltage | $V_{IN}$ | -0.3 to $V_{CC}$ +0.3 | V | |
| Output voltage | $V_{OUT}$ | -0.3 to $V_{CC}$ +0.3 | V | |
| Operating temperature | Topr | 0 to +70 | °C | |
| Storage temperature | Tstg | -55 to +150 | °C | |

**NOTE:**
1. The maximum applicable voltage on any pin with respect to GND.

## RECOMMENDED OPERATING CONDITIONS ($T_A$ = 0 to +70°C)

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|---|---|---|---|---|---|
| Supply voltage | $V_{CC}$ | 4.5 | 5.0 | 5.5 | V |

## DC CHARACTERISTICS ($V_{CC}$ = 5 V ± 10%, $T_A$ = 0 to +70°C)

| PARAMETER | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNIT | NOTE |
|---|---|---|---|---|---|---|---|
| Input 'Low' voltage | $V_{IL}$ | | -0.3 | | 0.8 | V | |
| Input 'High' voltage | $V_{IH}$ | | 2.2 | | $V_{CC}$ +0.3 | V | |
| Output 'Low' voltage | $V_{OL}$ | $I_{OL}$ = 2.0 mA | | | 0.4 | V | |
| Output 'High' voltage | $V_{OH}$ | $I_{OH}$ = -400 µA | 2.4 | | | V | |
| Input leakage current | $\lvert I_{LI} \rvert$ | $V_{IN}$ = 0 V to $V_{CC}$ | | | 10 | µA | |
| Output leakage current | $\lvert I_{LO} \rvert$ | $V_{OUT}$ = 0 V to $V_{CC}$ | | | 10 | µA | 1 |
| Operating current | $I_{CC1}$ | $t_{RC}$ = 100 ns | | | 100 | mA | 2 |
| | $I_{CC2}$ | $t_{RC}$ = 1 µs | | | 70 | | |
| | $I_{CC3}$ | $t_{RC}$ = 100 ns | | | 100 | mA | 3 |
| | $I_{CC4}$ | $t_{RC}$ = 1 µs | | | 70 | | |
| Standby current | $I_{SB1}$ | $\overline{CE}$ = $V_{IH}$ | | | 3 | mA | |
| | $I_{SB2}$ | $\overline{CE}$ = $V_{CC}$ - 0.2 V | | | 300 | µA | |

**NOTES:**
1. OE = $V_{IL}$, $\overline{CE}$/$\overline{OE}$ = $V_{IH}$
2. $V_{IN}$ = $V_{IH}$/$V_{IL}$, $\overline{CE}$ = $V_{IL}$, outputs open
3. $V_{IN}$ = ($V_{CC}$ - 0.2 V) or 0.2 V, $\overline{CE}$ = 0.2 V, outputs open

## AC CHARACTERISTICS ($V_{CC}$ = 5 V ± 10%, $T_A$ = 0 to +70°C)

| PARAMETER | SYMBOL | LH534600 | | | UNIT | NOTE |
|---|---|---|---|---|---|---|
| | | MIN. | TYP. | MAX. | | |
| Read cycle time | $t_{RC}$ | 100 | | | ns | |
| Address access time | $t_{AA}$ | | | 100 | ns | |
| Chip enable access time | $t_{ACE}$ | | | 100 | ns | |
| Output enable delay time | $t_{OE}$ | | | 40 | ns | |
| Output hold time | $t_{OH}$ | 5 | | | ns | |
| CE to output in High-Z | $t_{CHZ}$ | | | 40 | ns | 1 |
| OE to ouput in High-Z | $t_{OHZ}$ | | | 40 | ns | |

**NOTE:**
1. This is the time required for the outputs to become high-impedance.

## AC TEST CONDITIONS

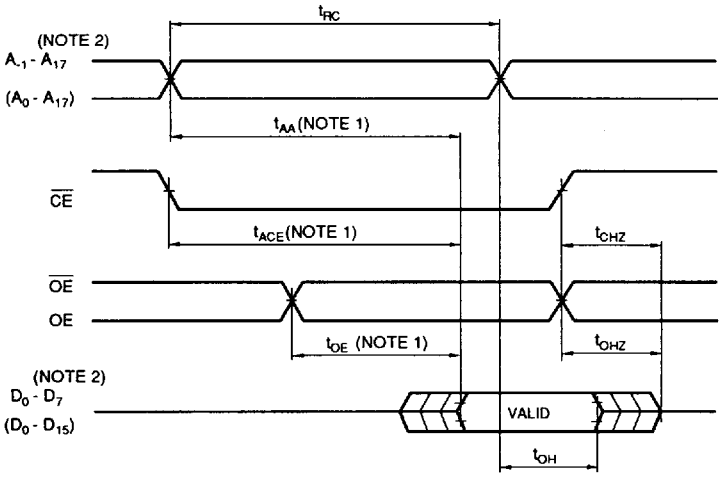
| PARAMETER | RATING |
|---|---|
| Input voltage amplitude | 0.6 V to 2.4 V |
| Input rise/fall time | 10 ns |
| Input reference level | 1.5 V |
| Output reference level | 1.5 V |
| Output load condition | 1TTL +100 pF |

## CAPACITANCE ($V_{CC}$ = 5 V ± 10%, f = 1 MHz, $T_A$ = 25°C)

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|---|---|---|---|---|---|
| Input capacitance | $C_{IN}$ | | | 10 | pF |
| Output capacitance | $C_{OUT}$ | | | 10 | pF |

## CAUTION

To stabilize the power supply, it is recommended that a high-frequency bypass capacitor be connected between the $V_{CC}$ pin and the GND pin.




**NOTES:**

1. Data becomes valid after the intervals $t_{AA}$, $t_{ACE}$ and $t_{OE}$ from address input and output enable input, respectively have been met.
2. Apply to byte mode. Signals in parentheses apply to word mode.

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**Figure 3. Timing Diagram**

## ORDERING INFORMATION